Order Number: MPC9315/D Rev 2, 02/2002

2.5V and 3.3V CMOS PLL **Clock Generator and Driver**

The MPC9315 is a 2.5V and 3.3V compatible, PLL based clock generator designed for low-skew clock distribution in low-voltage mid-range to high-performance telecom, networking and computing applications. The MPC9315 offers 8 low-skew outputs and 2 selectable inputs for clock redundancy. The outputs are configurable and support 1:1, 2:1, 4:1, 1:2 and 1:4 output to input frequency ratios. In addition, a selectable output 180° phase control supports advanced clocking schemes with inverted clock signals. The MPC9315 is specified for the extended temperature range of -40 to +85°C.

Features

- Configurable 8 outputs LVCMOS PLL clock generator
- Compatible to various microprocessor such as PowerQuicc I and II
- Wide range output clock frequency of 18.75 to 160 MHz
- 2.5V and 3.3V CMOS compatible
- Designed for mid-range to high-performance telecom, networking and computer applications
- Fully integrated PLL supports spread spectrum clocking
- Supports applications requiring clock redundancy
- Max. output skew of 120 ps (80 ps within one bank)
- Selectable output configurations (1:1, 2:1, 4:1, 1:2, 1:4 frequency ratios)
- 2 selectable LVCMOS clock inputs
- External PLL feedback path and selectable feedback configuration
- Tristable outputs
- 32 ld LQFP package
- Ambient operating temperature range of –40 to +85°C

Functional Description

The MPC9315 utilizes PLL technology to frequency and phase lock its outputs onto an input reference clock. Normal operation requires a connection of one of the device outputs to the selected feedback (FB0 or FB1) input to close the PLL feedback path. The reference clock frequency and the output divider for the feedback path determine the VCO frequency. Both must be selected to match the VCO frequency range. With available output dividers of divide-by-1, divide-by-2 and divide-by-4 the internal VCO of the MPC9315 is running at either 1x, 2x or 4x of the reference clock frequency. The frequency of the QA, QB, QC output groups is either the equal, one half or one fourth of the selected VCO frequency and can be configured for each output bank using the FSELA, FSELB and FSELC pins, respectively. The available output to input frequency ratios are 4:1, 2:1, 1:1, 1:2 and 1:4. The REF_SEL pin selects one of the two available LVCMOS compatible reference input (CLK0 and CLK1) supporting clock redundant applications. The selectable feedback input pin allows the user to select different feedback configurations and input to output frequency ratios. The MPC9315 also provides a static test mode when the PLL supply pin (VCCA) is pulled to logic low state (GND). In test mode, the selected input reference clock is routed directly to the output dividers bypassing the PLL. The test mode is intended for system diagnostics, test and debug purpose. This test mode is fully static and the minimum clock frequency specification does not apply. The outputs can be disabled by deasserting the OE pin (logic high state). In PLL mode, deasserting OE causes the PLL to lose lock due to no feedback signal presence at FB0 or FB1. Asserting OE will enable the outputs and close the phase locked loop, also enabling the PLL to recover to normal operation. The MPC9315 is fully 2.5V and 3.3V compatible and requires no external loop filter components. All inputs accept LVCMOS signals while the outputs provide LVCMOS compatible levels with the capability to drive terminated 50 Ω transmission lines. For series terminated transmission lines, each of the MPC9315 outputs can drive one or two traces giving the devices an effective fanout of 1:18. The device is packaged in a 7x7 mm² 32-lead LQFP package.

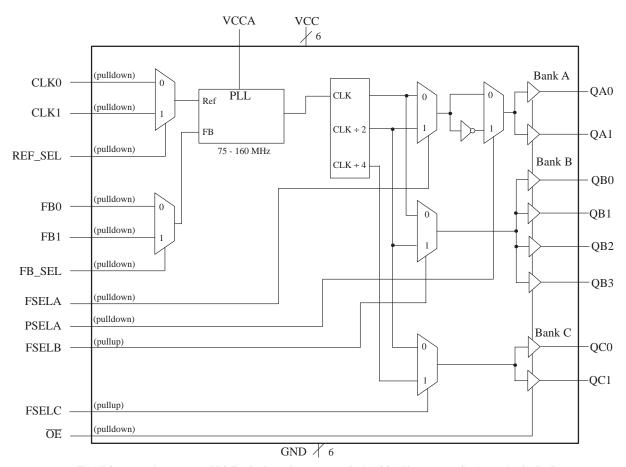
The fully integrated PLL of the MPC9315 allows the low skew outputs to lock onto a clock input and distribute it with essentially zero propagation delay to multiple components on the board. In zero-delay buffer mode, the PLL minimizes phase offset between the outputs and the reference signal.

MPC9315

LOW VOLTAGE 2.5V AND 3.3V PLL **CLOCK GENERATOR**



FA SUFFIX LQFP PACKAGE CASE 873A-02



The MPC9315 requires an external RC filter for the analog power supply pin VCCA. Please see application section for details.

Figure 1. MPC9315 Logic Diagram

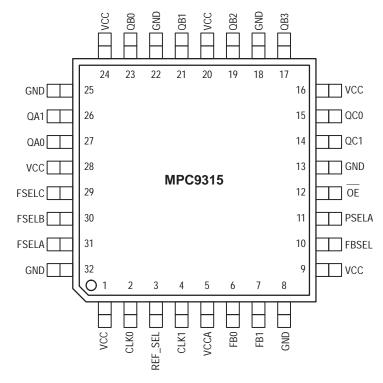


Figure 2. Pinout: 32-Lead Package Pinout (Top View)

PIN CONFIGURATION

| Pin | I/O | Туре | Function |
|------------|--------|--------|--|
| CLK0 | Input | LVCMOS | Reference clock input |
| CLK1 | Input | LVCMOS | Alternative clock input |
| FB0 | Input | LVCMOS | PLL feedback input |
| FB1 | Input | LVCMOS | Alternative feedback input |
| REF_SEL | Input | LVCMOS | Selects clock input reference clock input, default low (pull-down) |
| FB_SEL | Input | LVCMOS | Selects PLL feedback clock input, default low (pull-down) |
| FSELA | Input | LVCMOS | Selects divider ratio of bank A outputs, default low (pull-down) |
| FSELB | Input | LVCMOS | Selects divider ratio of bank B outputs, default low (pull-up) |
| FSELC | Input | LVCMOS | Selects divider ratio of bank C outputs, default low (pull-up) |
| PSELA | Input | LVCMOS | Selects phase of bank A outputs |
| QA0, QA1 | Output | LVCMOS | Bank A outputs |
| QB0 to QB3 | Output | LVCMOS | Bank B outputs |
| QC0, QC1 | Output | LVCMOS | Bank C outputs |
| OE | Input | LVCMOS | Output tristate |
| VCCA | | Supply | Analog (PLL) positive supply voltage. Requires external RC filter |
| VCC | | Supply | Digital positive supply voltage |
| GND | | Ground | Digital negative supply voltage (ground) |

FUNCTION TABLE

| Control | Default | 0 | 1 |
|---------|---------|--|--|
| REF_SEL | 0 | CLK0 | CLK1 |
| FB_SEL | 0 | FB0 | FB1 |
| FSELA | 0 | QAx = VCO clock frequency | QA0, QA1 = VCO clock frequency ÷ 2 |
| FSELB | 1 | QBx = VCO clock frequency | QB0 - QB3 = VCO clock frequency ÷ 2 |
| FSELC | 1 | QCx = VCO clock frequency ÷ 2 | QC0, QC1 = VCO clock frequency ÷ 4 |
| PSELA | 0 | 0° (QA0, QA1 non-inverted) | 180° (QA0, QA1 inverted) |
| VCCA | none | VCCA = GND, PLL off and bypassed for static test and diagnosis | VCCA = 3.3 or 2.5V, PLL enabled |
| MR | 0 | Normal operation | Reset (VCO clamped to min. range) |
| OE | 0 | Outputs enabled | Outputs disabled (tristate), open PLL loop |

ABSOLUTE MAXIMUM RATINGSa

| Symbol | Characteristics | Min | Max | Unit | Condition |
|-----------------|---------------------|------|----------------------|------|-----------|
| VCC | Supply Voltage | -0.3 | 4.6 | V | |
| VIN | DC Input Voltage | -0.3 | V _{CC} +0.3 | V | |
| Vout | DC Output Voltage | -0.3 | V _{CC} +0.3 | V | |
| I _{IN} | DC Input Current | | ±20 | mA | |
| IOUT | DC Output Current | | ±50 | mA | |
| TS | Storage temperature | -55 | 125 | °C | |

a. Absolute maximum continuos ratings are those maximum values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

GENERAL SPECIFICATIONS

| Symbol | Characteristics | Min | Тур | Max | Unit | Condition |
|-----------------|-------------------------------|------|---------------------|-----|------|------------|
| VTT | Output Termination Voltage | | V _{CC} ÷ 2 | | V | |
| MM | ESD (Machine Model) | 200 | | | V | |
| HBM | ESD (Human Body Model) | 2000 | | | V | |
| LU | Latch-Up | 200 | | | mA | |
| C _{PD} | Power Dissipation Capacitance | | 10 | | pF | Per output |
| C _{IN} | | | 4.0 | | pF | Inputs |

DC CHARACTERISTICS ($V_{CC} = 3.3V \pm 5\%$, $T_A = -40^{\circ}$ to 85° C)

| Symbol | Characteristics | Min | Тур | Max | Unit | Condition |
|-----------------|----------------------------------|-----|---------|-----------------------|------|---|
| VIH | Input High Voltage | 2.0 | | V _{CC} + 0.3 | V | LVCMOS |
| V _{IL} | Input Low Voltage | | | 0.8 | V | LVCMOS |
| Vон | Output High Voltage | 2.4 | | | V | I _{OH} =-24 mA ^a |
| VOL | Output Low Voltage | | | 0.55 0.30 | V | I _{OL} = 24mA ^a I _{OL} = 12mA |
| ZOUT | Output Impedance | | 14 - 17 | | Ω | |
| I _{IN} | Input Current ^b | | | ±200 | μΑ | $V_{IN} = V_{CC}$ or GND |
| ICCA | Maximum PLL Supply Current | | 3.5 | 7.0 | mA | V _{CCA} Pin |
| Iccq | Maximum Quiescent Supply Current | | | 1.0 | mA | All V _{CC} Pins |

a. The MPC9315 is capable of driving 50Ω transmission lines on the incident edge. Each output drives one 50Ω parallel terminated transmission line to a termination voltage of V_{TT} . Alternatively, the device drives up to two 50Ω series terminated transmission lines.

AC CHARACTERISTICS ($V_{CC} = 3.3V \pm 5\%$, $T_A = -40^{\circ}$ to $85^{\circ}C$)^a

| Symbol | Characteristics | Min | Тур | Max | Unit | Condition |
|---------------------------------|---|------------------------------------|------------------------------|-----------------|-------------------|--|
| f _{ref} | Input Frequency ÷1 feedback ÷2 feedback ÷4 feedback | 100 ^c 37.50 18.75 | | 160 80 40 | MHz MHz MHz | PLL locked PLL locked PLL locked |
| | PLL bypass mode | 0 | | TBD | MHz | V _{CCA} = GND |
| fvco | VCO Lock Range | 75 ^C | | 160 | MHz | |
| fMAX | Maximum Output Frequency ÷1 output ÷2 output ÷4 output | 75 37.50 18.75 | | 160 80 40 | MHz MHz MHz | |
| frefDC | Reference Input Duty Cycle | 25 | | 75 | % | |
| t _r , t _f | CLK0, CLK1 Input Rise/Fall Time | | | 1.0 | ns | 0.8 to 2.0V |
| t(∅) | Propagation Delay CLK0 or CLK1 to FB (Static Phase Offset) | -150 | | +150 | ps | PLL locked |
| tSK(∅) | Output-to-Output Skew Within one bank Any output | | | 80 120 | ps ps | |
| DC | Output Duty Cycle | 45 | 50 | 55 | % | |
| t _r , t _f | Output Rise/Fall Time | 0.1 | | 1.0 | ns | 0.55 to 2.4V |
| ^t PLZ, HZ | Output Disable Time | | | 10 | ns | |
| ^t PZL, LZ | Output Enable Time | | | 10 | ns | |
| BW | PLL closed loop bandwidth +1 feedback +2 feedback +4 feedback | | TBD 2.0 – 20 0.6 – 6.0 | | MHz MHz MHz | |
| tJIT(CC) | Cycle-to-Cycle Jitter (1σ) | | 10 | 22 | ps | RMS value |
| tJIT(PER) | Period Jitter (1 σ) | | 8.0 | 15 | ps | RMS value |
| tJIT(∅) | I/O Phase Jitter (1σ) | | 8.0 – 25 ^b | TBD | ps | RMS value |
| tLOCK | Maximum PLL Lock Time | | | 1.0 | ms | |

a. AC characteristics apply for parallel output termination of 50Ω to V_{TT}.

b. Inputs have pull-up or pull-down resistors affecting the input current.

b. I/O jitter depends on VCO frequency. Please see application section for I/O jitter versus VCO frequency characteristics.

c. The VCO range in \div 1 feedback configuration (e.g. QAx connected to FBx and FSELA = 0) is limited to $100 \le f_{VCO} \le 160$ MHz. Please see next revision of the MPC9315 for improved VCO frequency range.

DC CHARACTERISTICS ($V_{CC} = 2.5V \pm 5\%$, $T_A = -40^{\circ}$ to 85° C)

| Symbol | Characteristics | Min | Тур | Max | Unit | Condition |
|-----------------|----------------------------------|-----|---------|-----------------------|------|--|
| VIH | Input High Voltage | 1.7 | | V _{CC} + 0.3 | V | LVCMOS |
| V _{IL} | Input Low Voltage | | | 0.7 | V | LVCMOS |
| Voн | Output High Voltage | 1.8 | | | V | I _{OH} =-15 mA ^a |
| VOL | Output Low Voltage | | | 0.6 | V | I _{OL} = 15 mA |
| ZOUT | Output Impedance | | 17 - 20 | | Ω | |
| I _{IN} | Input Current ^b | | | ±200 | μΑ | V _{IN} = V _{CC} or GND |
| ICCA | Maximum PLL Supply Current | | 2.0 | 5.0 | mA | V _{CCA} Pin |
| ICCQ | Maximum Quiescent Supply Current | | | 1.0 | mA | All V _{CC} Pins |

a. The MPC9315 is capable of driving 50Ω transmission lines on the incident edge. Each output drives one 50Ω parallel terminated transmission line to a termination voltage of V_{TT}. Alternatively, the device drives up to two 50Ω series terminated transmission lines per output.

AC CHARACTERISTICS ($V_{CC} = 2.5V \pm 5\%$, $T_A = -40^{\circ}$ to 85° C)²

| Symbol | Characteristics | Min | Тур | Max | Unit | Condition |
|---------------------------------|--|----------------------|-----------------------|------------------|-------------------|--------------------------|
| fref | Input Frequency ^C ÷2 feedback ÷4 feedback | 37.50 18.75 | | 80 40 | MHz MHz | PLL locked PLL locked |
| | PLL bypass mode | 0 | | TBD | MHz | V _{CCA} = GND |
| fvco | VCO Lock Range | 75 ^C | | 160 ^c | MHz | |
| f _{MAX} | Maximum Output Frequency ÷1 output ÷2 output ÷4 output | 75 37.50 18.75 | | 160 80 50 | MHz MHz MHz | |
| frefDC | Reference Input Duty Cycle | 25 | | 75 | % | |
| t _r , t _f | CLK0, CLK1 Input Rise/Fall Time | | | 1.0 | ns | 0.7 to 1.7V |
| t(∅) | Propagation Delay CLK0 or CLK1 to FB (Static Phase Offset) | -150 | | +150 | ps | PLL locked |
| ^t SK(∅) | Output-to-Output Skew Within one bank Any output | | | 80 120 | ps ps | |
| DC | Output Duty Cycle | 45 | 50 | 55 | % | |
| t _r , t _f | Output Rise/Fall Time | 0.1 | | 1.0 | ns | 0.55 to 2.4V |
| ^t PLZ, HZ | Output Disable Time | | | 12 | ns | |
| tPZL, LZ | Output Enable Time | | | 12 | ns | |
| BW | PLL closed loop bandwidth +2 feedback +4 feedback | | 1.0 – 10 0.4 – 3.0 | | MHz MHz | |
| tJIT(CC) | Cycle-to-Cycle Jitter (1σ) | | 10 | 22 | ps | RMS value |
| tJIT(PER) | Period Jitter (1σ) | | 8.0 | 15 | ps | RMS value |
| tJIT(∅) | I/O Phase Jitter (1σ) | | 10 – 25 ^b | TBD | ps | RMS value |
| tLOCK | Maximum PLL Lock Time | | | 1.0 | ms | |

a. AC characteristics apply for parallel output termination of 50Ω to V_{TT} .

b. Inputs have pull-up or pull-down resistors affecting the input current.

b. I/O jitter depends on VCO frequency. Please see application section for I/O jitter versus VCO frequency characteristics.

c. ± 1 feedback is not available for $V_{CC} = 2.5V$ operation. Please see next revision of the MPC9315 for the ± 1 feedback option at 2.5V supply.

APPLICATIONS INFORMATION

Programming the MPC9315

The PLL of the MPC9315 supports output clock frequencies from 18.75 to 160 MHz. Different feedback and output divider configurations can be used to achieve the desired input to output frequency relationship. The feedback frequency and divider should be used to situate the VCO in the frequency range between 75 and 160 MHz for stable and optimal operation. The FSELA, FSELB, FSELC pins select the desired output clock frequencies. Possible frequency

ratios of the reference clock input to the outputs are 1:1, 1:2, 1:4 as well as 2:1 and 4:1, Table 1, Table 2 and Table 3 illustrate the various output configurations and frequency ratios supported by the MPC9315. PSELA controls the output phase of the QA0 and QA1 outputs, allowing the user to generate inverted clock signals synchronous to non-inverted clock signals. See also "Example Configurations for the MPC9315" on page 8 for further reference.

Table 1: Output Frequency Relationship for QA0 connected to FB0a

| Inputs | | | Outputs | | |
|--------|-------|-------|----------|---------|----------|
| FSELA | FSELB | FSELC | QA0, QA1 | QB0-QB3 | QC0, QC1 |
| 0 | 0 | 0 | CLK | CLK | CLK ÷ 2 |
| 0 | 0 | 1 | CLK | CLK | CLK ÷ 4 |
| 0 | 1 | 0 | CLK | CLK ÷ 2 | CLK ÷ 2 |
| 0 | 1 | 1 | CLK | CLK ÷ 2 | CLK ÷ 4 |
| 1 | 0 | 0 | CLK | 2 * CLK | CLK |
| 1 | 0 | 1 | CLK | 2 * CLK | CLK ÷ 2 |
| 1 | 1 | 0 | CLK | CLK | CLK |
| 1 | 1 | 1 | CLK | CLK | CLK ÷ 2 |

a. Output frequency relationship with respect to input reference frequency CLK.

Table 2: Output Frequency Relationship for QB0 connected to FB0a

| Inputs | | | Outputs | | |
|--------|-------|-------|----------|---------|----------|
| FSELA | FSELB | FSELC | QA0, QA1 | QB0-QB3 | QC0, QC1 |
| 0 | 0 | 0 | CLK | CLK | CLK ÷ 2 |
| 0 | 0 | 1 | CLK | CLK | CLK ÷ 4 |
| 0 | 1 | 0 | 2 * CLK | CLK | CLK |
| 0 | 1 | 1 | 2 * CLK | CLK | CLK ÷ 2 |
| 1 | 0 | 0 | CLK ÷ 2 | CLK | CLK ÷ 2 |
| 1 | 0 | 1 | CLK ÷ 2 | CLK | CLK ÷ 4 |
| 1 | 1 | 0 | CLK | CLK | CLK |
| 1 | 1 | 1 | CLK | CLK | CLK ÷ 2 |

a. Output frequency relationship with respect to input reference frequency CLK.

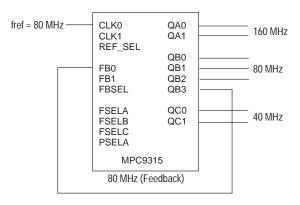
Table 3: Output Frequency Relationship for QC0 connected to FB0a

| | Inputs | | | Outputs | | |
|-------|--------|-------|----------|---------|----------|--|
| FSELA | FSELB | FSELC | QA0, QA1 | QB0-QB3 | QC0, QC1 | |
| 0 | 0 | 0 | 2 * CLK | 2 * CLK | CLK | |
| 0 | 0 | 1 | 4 * CLK | 4 * CLK | CLK | |
| 0 | 1 | 0 | 2 * CLK | CLK | CLK | |
| 0 | 1 | 1 | 4 * CLK | 2 * CLK | CLK | |
| 1 | 0 | 0 | CLK | 2 * CLK | CLK | |
| 1 | 0 | 1 | 2 * CLK | 4 * CLK | CLK | |
| 1 | 1 | 0 | CLK | CLK | CLK | |
| 1 | 1 | 1 | 2 * CLK | 2 * CLK | CLK | |

a. Output frequency relationship with respect to input reference frequency CLK.

Example Configurations for the MPC9315

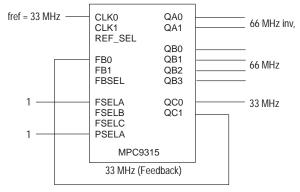
Figure 3. MPC9315 Default Configuration



MPC9315 default configuration (feedback of QB3 = 100 MHz). All control pins are left open.

| Frequency range | Min | Max |
|-----------------|-----------|---------|
| Input | 37.50 MHz | 80 MHz |
| QA outputs | 75.00 MHz | 160 MHz |
| QB outputs | 37.50 MHz | 80 MHz |
| QC outputs | 18.75 MHz | 40 MHz |

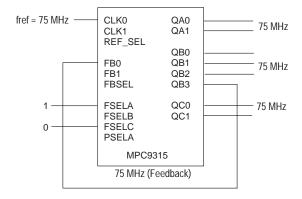
Figure 5. MPC9315 180° Phase Inversion Configuration



MPC9315 1:1 frequency configuration (feedback of QC1 = 33 MHz). FSELA = PSELA = H. All other control pins are left open.

| Frequency range | Min | Max |
|-----------------|-----------|--------|
| Input | 18.75 MHz | 40 MHz |
| QA outputs | 37.50 MHz | 80 MHz |
| QB outputs | 37.50 MHz | 80 MHz |
| QC outputs | 18.75 MHz | 40 MHz |

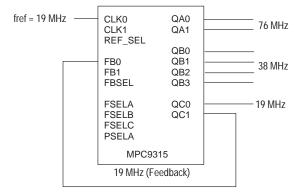
Figure 4. MPC9315 Zero Delay Buffer Configuration



MPC9315 1:1 frequency configuration (feedback of QB3 = 75 MHz). FSELA = H, FSELC = L. All other control pins are left open.

| Frequency range | Min | Max | |
|-----------------|-----------|--------|--|
| Input | 37.50 MHz | 80 MHz | |
| QA outputs | 37.50 MHz | 80 MHz | |
| QB outputs | 37.50 MHz | 80 MHz | |
| QC outputs | 37.50 MHz | 80 MHz | |

Figure 6. MPC9315 x4 Multiplier Configuration



MPC9315 4x, 2x, 1x frequency configuration (feedback of QC1 = 19 MHz). All control pins are left open.

| Frequency range | Min | Max |
|-----------------|-----------|---------|
| Input | 18.75 MHz | 40 MHz |
| QA outputs | 75.00 MHz | 160 MHz |
| QB outputs | 37.50 MHz | 80 MHz |
| QC outputs | 18.75 MHz | 40 MHz |

Using the MPC9315 in zero-delay applications

The external feedback option of the MPC9315 PLL allows for its use as a zero delay buffer. The PLL aligns the feedback clock output edge with the clock input reference edge and virtually eliminates the propagation delay through the device.

The remaining insertion delay (skew error) of the MPC9315 in zero-delay applications is measured between the reference clock input and any output. This effective delay consists of the static phase offset (SPO or $t(\varnothing))$, I/O jitter $(t_{JIT}(\varnothing))$, phase or long-term jitter), feedback path delay and the output-to-output skew $(t_{SK(O)})$ relative to the feedback output.

Calculation of part-to-part skew

The MPC9315 zero delay buffer supports applications where critical clock signal timing can be maintained across several devices. If the reference clock inputs (TCLK or PCLK) of two or more MPC9315 are connected together, the maximum overall timing uncertainty from the common TCLK input to any output is:

$$tSK(PP) = t(\emptyset) + tSK(O) + tPD$$
, $LINE(FB) + tJIT(\emptyset) \cdot CF$

This maximum timing uncertainty consists of 4 components: static phase offset, output skew, feedback board trace delay and I/O (phase) jitter:

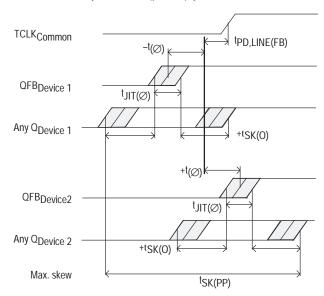


Figure 7. MPC9315 max. device-to-device skew

Due to the statistical nature of I/O jitter, a RMS value (1 σ) is specified. I/O jitter numbers for other confidence factors (CF) can be derived from Table 8.

Table 8: Confidence Facter CF

| CF | Probability of clock edge within the distribution | | | |
|------|---|--|--|--|
| ±1σ | 0.68268948 | | | |
| ± 2σ | 0.95449988 | | | |
| ± 3σ | 0.99730007 | | | |
| ± 4σ | 0.99993663 | | | |
| ± 5σ | 0.9999943 | | | |
| ± 6σ | 0.9999999 | | | |

The feedback trace delay is determined by the board layout and can be used to fine-tune the effective delay through each device. In the following example calculation a I/O jitter confidence factor of 99.7% (\pm 3 σ) is assumed, resulting in a worst case timing uncertainty from input to any output of -300 ps to +300 ps relative to TCLK (V_{CC}=3.3V and fV_{CO} = 160 MHz):

$$tsK(PP) = [-150ps...150ps] + [-150ps...150ps] + [(10ps \cdot -3)...(10ps \cdot 3)] + tpD, LINE(FB)$$

$$tSK(PP) = [-300ps...300ps] + tPD, LINE(FB)$$

Above equation uses the maximum I/O jitter number shown in the AC characteristic table for $V_{CC}=3.3V$ (10 ps RMS). I/O jitter is frequency dependant with a maximum at the lowest VCO frequency (160 MHz for the MPC9315). Applications using a higher VCO frequency exhibit less I/O jitter than the AC characteristic limit. The I/O jitter characteristics in Figure 8. and Figure 9. can be used to derive a smaller I/O jitter number at the specific VCO frequency, resulting in tighter timing limits in zero-delay mode and for part-to-part skew $t_{SK(PP)}$.

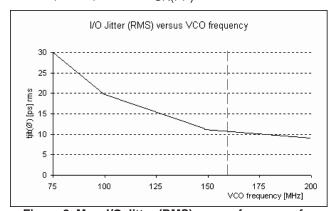


Figure 8. Max. I/O Jitter (RMS) versus frequency for $V_{CC}=2.5V$

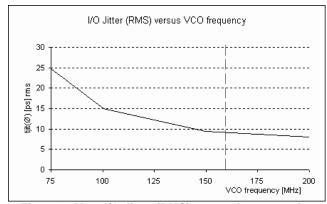


Figure 9. Max. I/O Jitter (RMS) versus frequency for V_{CC}=3.3V

Power Supply Filtering

The MPC9315 is a mixed analog/digital product. Its analog circuitry is naturally susceptible to random noise, especially if this noise is seen on the power supply pins. Noise on the V_{CCA} (PLL) power supply impacts the device characteristics, for instance I/O jitter. The MPC9315 provides separate power

supplies for the output buffers (VCC) and the phase-locked loop (VCCA) of the device. The purpose of this design technique is to isolate the high switching noise digital outputs from the relatively sensitive internal analog phase-locked loop. In a digital system environment where it is more difficult to minimize noise on the power supplies, a second level of isolation may be required. The simple but effective form of isolation is a power supply filter on the VCCA pin for the MPC9315. Figure 10. illustrates a typical power supply filter scheme. The MPC9315 frequency and phase stability is most susceptible to noise with spectral content in the 100kHz to 20MHz range. Therefore the filter should be designed to target this range. The key parameter that needs to be met in the final filter design is the DC voltage drop across the series filter resistor RF. From the data sheet the ICCA current (the current sourced through the VCCA pin) is typically 3 mA (5 mA maximum), assuming that a minimum of 2.325V (VCC=3.3V or V_{CC}=2.5V) must be maintained on the V_{CCA} pin. The resistor RF shown in Figure 10. "VCCA Power Supply Filter" must have a resistance of 270 Ω (V_{CC}=3.3V) or 9-10 Ω (V_{CC}=2.5V) to meet the voltage drop criteria.

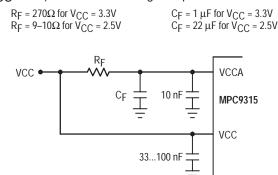


Figure 10. V_{CCA} Power Supply Filter

The minimum values for RF and the filter capacitor CF are defined by the required filter characteristics: the RC filter should provide an attenuation greater than 40 dB for noise whose spectral content is above 100 kHz. In the example RC filter shown in Figure 10. "VCCA Power Supply Filter", the filter cut-off frequency is around 3-5 kHz and the noise attenuation at 100 kHz is better than 42 dB.

As the noise frequency crosses the series resonant point of an individual capacitor, its overall impedance begins to look inductive and thus increases with increasing frequency. The parallel capacitor combination shown ensures that a low impedance path to ground exists for frequencies well above the bandwidth of the PLL. Although the MPC9315 has several design features to minimize the susceptibility to power supply noise (isolated power and grounds and fully differential PLL) there still may be applications in which overall performance is being degraded due to system power supply noise. The power supply filter schemes discussed in this section should be adequate to eliminate power supply noise related problems in most designs.

Driving Transmission Lines

The MPC9315 clock driver was designed to drive high speed signals in a terminated transmission line environment. To provide the optimum flexibility to the user the output

drivers were designed to exhibit the lowest impedance possible. With an output impedance of less than 20Ω the drivers can drive either parallel or series terminated transmission lines. For more information on transmission lines the reader is referred to Motorola application note AN1091. In most high performance clock networks point-to-point distribution of signals is the method of choice. In a point-to-point scheme either series terminated or parallel terminated transmission lines can be used. The parallel technique terminates the signal at the end of the line with a 50Ω resistance to $V_{\rm CC}\div2$.

This technique draws a fairly high level of DC current and thus only a single terminated line can be driven by each output of the MPC9315 clock driver. For the series terminated case however there is no DC current draw, thus the outputs can drive multiple series terminated lines. Figure 11. "Single versus Dual Transmission Lines" illustrates an output driving a single series terminated line versus two series terminated lines in parallel. When taken to its extreme the fanout of the MPC9315 clock driver is effectively doubled due to its capability to drive multiple lines.

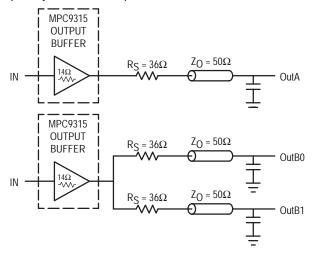


Figure 11. Single versus Dual Transmission Lines

The waveform plots in Figure 12. "Single versus Dual Line Termination Waveforms" show the simulation results of an output driving a single line versus two lines. In both cases the drive capability of the MPC9315 output buffer is more than sufficient to drive 50Ω transmission lines on the incident edge. Note from the delay measurements in the simulations a delta of only 43ps exists between the two differently loaded outputs. This suggests that the dual line driving need not be used exclusively to maintain the tight output-to-output skew of the MPC9315. The output waveform in Figure 12. "Single versus Dual Line Termination Waveforms" shows a step in the waveform, this step is caused by the impedance mismatch seen looking into the driver. The parallel combination of the 36Ω series resistor plus the output impedance does not match the parallel combination of the line impedances. The voltage wave launched down the two lines will equal:

$$V_L = V_S (Z_0 \div (R_S + R_0 + Z_0))$$

 $Z_0 = 50\Omega \parallel 50\Omega$
 $R_S = 36\Omega \parallel 36\Omega$
 $R_0 = 14\Omega$

$$V_L = 3.0 (25 \div (18+17+25)$$

= 1.31V

At the load end the voltage will double, due to the near unity reflection coefficient, to 2.6V. It will then increment towards the quiescent 3.0V in steps separated by one round trip delay (in this case 4.0ns).

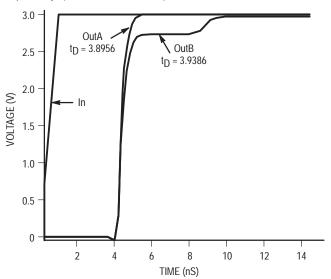


Figure 12. Single versus Dual Waveforms

Since this step is well above the threshold region it will not cause any false clock triggering, however designers may be uncomfortable with unwanted reflections on the line. To better match the impedances when driving multiple lines the situation in Figure 13. "Optimized Dual Line Termination" should be used. In this case the series terminating resistors are reduced such that when the parallel combination is added to the output buffer impedance the line impedance is perfectly matched.

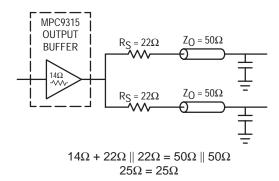


Figure 13. Optimized Dual Line Termination

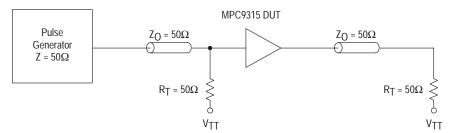


Figure 14. CLK0, CLK1 MPC9315 AC test reference

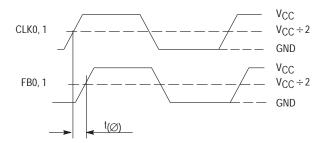
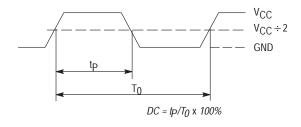
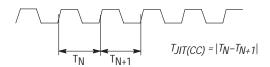


Figure 15. Propagation delay (t_(∅), SPO) test reference



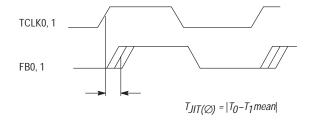
The time from the PLL controlled edge to the non controlled edge, divided by the time between PLL controlled edges, expressed as a percentage

Figure 16. Output Duty Cycle (DC)



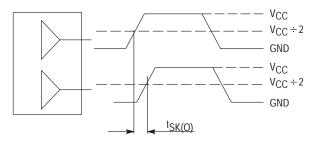
The variation in cycle time of a signal between adjacent cycles, over a random sample of adjacent cycle pairs

Figure 18. Cycle-to-cycle Jitter



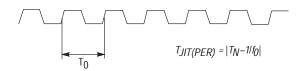
The deviation in t_0 for a controlled edge with respect to a t_0 mean in a random sample of cycles

Figure 20. I/O Jitter



The pin-to-pin skew is defined as the worst case difference in propagation delay between any similar delay path within a single device

Figure 17. Output-to-output Skew tSK(O)



The deviation in cycle time of a signal with respect to the ideal period over a random sample of cycles

Figure 19. Period Jitter

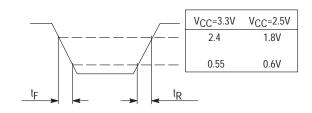
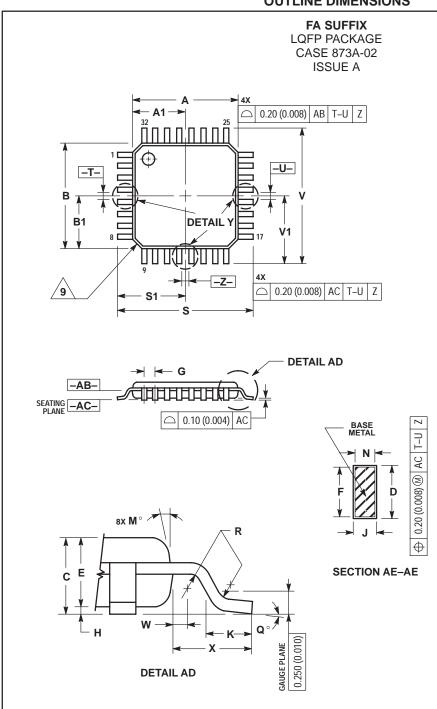
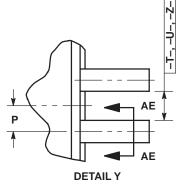


Figure 21. Output Transition Time Test Reference

OUTLINE DIMENSIONS





- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- DATUM PLANE -AB- IS LOCATED AT BOTTOM
 OF LEAD AND IS COINCIDENT WITH THE LEAD OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.

 DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.

 DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -AC-.

 DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTEINSION ALL QUARDLE PROTEINSION IS

- PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
- 7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.520 (0.020).
- 0.320 (0.020).

 8. MINIMUM SOLDER PLATE THICKNESS SHALL BE 0.0076 (0.0003).

 9. EXACT SHAPE OF EACH CORNER MAY VARY FROM DEPICTION.

| | MILLIMETERS | | INCHES | |
|-----|---------------------|---------------------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 7.000 BSC | | 0.276 BSC | |
| A1 | 3.500 BSC | | 0.138 BSC | |
| В | 7.000 BSC | | 0.276 BSC | |
| B1 | 3.500 BSC | | 0.138 BSC | |
| С | 1.400 | 1.600 | 0.055 | 0.063 |
| D | 0.300 | 0.450 | 0.012 | 0.018 |
| E | 1.350 | 1.450 | 0.053 | 0.057 |
| F | 0.300 | 0.400 | 0.012 | 0.016 |
| G | 0.800 BSC | | 0.031 BSC | |
| Н | 0.050 | 0.150 | 0.002 | 0.006 |
| J | 0.090 | 0.200 | 0.004 | 0.008 |
| K | 0.500 | 0.700 | 0.020 | 0.028 |
| M | 12° REF | | 12° REF | |
| N | 0.090 | 0.160 | 0.004 | 0.006 |
| P | 0.400 BSC | | 0.016 BSC | |
| Q | 1° | 5° | 1° | 5° |
| R | 0.150 | 0.250 | 0.006 | 0.010 |
| S | 9.000 BSC | | 0.354 BSC | |
| S1 | 4.500 BSC | | 0.177 BSC | |
| V | 9.000 BSC | | 0.354 BSC | |
| V1 | 4.500 BSC | | 0.177 BSC | |
| W | 0.200 | 0.200 REF 0.008 REF | | REF |
| Х | 1.000 REF 0.039 REF | | REF | |

NOTES

NOTES

NOTES

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